

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc2875hdd#trpbf

(Engineering Calculation)

DFN 3mm X 3mm Exp. Pad

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TOTAL MASS (g) : 0.023071

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001351	1000000	58557.4101562		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.009350	975000	405264.09375		
		Iron (Fe)	7439-89-6	0.000230	24000	9969.06347656		
		Phosphorus (P)	7723-14-0	0.000003	300	130.031265259		
		Zinc (Zn)	7440-66-6	0.000007	700	303.406280518		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.009590	1000000	415666.59375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000437	1000000	18957.4902344		
		External Plating Total:				0.000437	1000000	18957.4902344
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000218	1000000	9448.93847656		
Internal Plating Total:				0.000218	1000000	9448.93847656		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000692	750000	29993.875		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000231	250000	10012.40625		
Die Attach Total:				0.000923	1000000	40006.28125		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001368	130000	59294.2539062		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.009047	860000	392130.90625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000105	10000	4551.09423828		
		Encapsulation Total:				0.010520	1000000	455976.25
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000032	1000000	1387		
					TOTAL MASS (g) :	0.023071		